

Ashvin Nagarajan

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Education:

University of California, Los Angeles (UCLA) 2018 - 2022
B.S. Materials Science and Engineering Cumulative GPA: 4.00 / 4.00

Selected Projects:

Center for Heterogeneous Integration and Performance Scaling | Researcher 2019 – *

- ◆ Designing prototype flexible gas sensor for consumer applications in wearable technology
- ◆ Created communication protocol for analog and digital circuits using BLE and NFC
- ◆ Programmed proprietary MCUs in C to optimize data transfer over multiple ADC channels
- ◆ Fabricating etched sensors and PCBs in clean room environment

Super Mileage Vehicle | Research and Development Lead 2018 – *

- ◆ Developed vehicle data acquisition system w/ embedded sensors to create mathematical models
- ◆ Conducted mathematical analysis on burn algorithms to improve efficiency to 130+ mi/kWh
- ◆ Created driver interface to monitor data in real time with React, Redux, Python, C++, Firebase
- ◆ Designed rigorous SOPs to measure efficiency and ensure quality of improvements made on car

Booz Allen Hamilton | Software Engineer 2019

- ◆ Developed proprietary data visualization tool for Docker environments with Kubernetes
- ◆ Earned 1st Place Overall out of 81 intern teams judged by senior leadership at McLean HQ
- ◆ Provides insight on the health and performance of an AWS EC2 Cluster in real time
- ◆ Customizable UI for the needs of clients using React, Redux, JavaScript, Enterprise Architect

Creative Labs @ UCLA | Engineering Project Manager 2019 – *

- ◆ Leading team of 11 engineers to develop IoT coffee maker with mobile app and MCUs
- ◆ Implemented skills and features using React Native, Android, C++, and SolidWorks
- ◆ Developed the prototype of an IoT bean bag device by designing circuits and sensors
- ◆ Integrated mobile app and Google Home skill to control the electronic functionality

Skills:

React, Redux, JavaScript, Express, JQuery
Python, MATLAB, Java, C, C++
SolidWorks, NX, AutoCad
Sims for Thermal, Structural FEA, CFD

MCUs and Embedded Systems
Analog and Digital Circuits, PCB design
Data communication and transfer protocol
Systems Engineering with Enterprise Architect

Awards and Honors:

Engineering Dean List: 2018 – Present
1st Place Booz Allen Hamilton Summer Games
1st Place IdeaHacks Hardware Hackathon
Engineering Fellow – City Fellows Consortium

Valedictorian of JCHS Class of 2018
Eagle Scout – Boy Scout Troop 6: 2016
NMSC National Merit Scholar: 2018
National Honor Society: 2016 – 2018